Series 5322

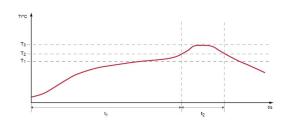
- · Short, compact size
- · Board-to-board contacting
- For use in charging units

Mechanical Data		
Center	2.54 mm/ 100 mil	
Full travel	1.40 mm	
Working travel	0.70 mm	
Pre-loaded spring force	0.25 N	
Spring force at working travel	0.85 N	

Electrical Data		
Max. current rating	3.5 A	
Typical continuity resistance	ty resistance <= 20 mOhm	

Materials			
Barrel	brass, gold plated		
Spring	spring steel, gold plated		
Plunger	brass, gold plated		
PAD Contact	brass, gold plated		
Test probe block	HT-plastic UL 94V-0,		

Soldering Profile Reflow



Recommendations					
Preheating Phase	Т,	180 °C			
	Duration	t,	< 240 s		
Soldering Phase	Duration	t,	< 60 s		
	Temperature, minimum	T ₂	217 °C		
	Temperature, maximum	T ₃	245 °C		
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